

SiGe:C LOW NOISE AMPLIFIER FOR GPS**DESCRIPTION**

The μ PC8236T6N is a silicon germanium carbon (SiGe:C) monolithic integrated circuit designed as low noise amplifier for GPS. This device exhibits low noise figure and high power gain characteristics, so this IC can improve the sensitivity of GPS receiver. In addition, the μ PC8236T6N which is included output matching circuit contributes to reduce external components and system size.

The package is a 6-pin plastic TSON (Thin Small Out-line Non-leaded) (T6N) suitable for surface mount.

This IC is manufactured using our UHS4 (Ultra High Speed Process) SiGe:C bipolar process.

FEATURES

- Supply voltage : $V_{CC} = 1.6$ to 3.3 V (2.7 V TYP.)
- Low noise : $NF = 0.8$ dB TYP. @ $V_{CC} = 2.7$ V, $f_{IN} = 1\ 575$ MHz
- High gain : $G_P = 19.5$ dB TYP. @ $V_{CC} = 2.7$ V, $f_{IN} = 1\ 575$ MHz
- Low current consumption : $I_{CC} = 6.5$ mA TYP. @ $V_{CC} = 2.7$ V
- Built-in power-saving function : $V_{PSon} = 1.0$ V to V_{CC} , $V_{PSoff} = 0$ to 0.4 V
- High-density surface mounting : 6-pin plastic TSON (T6N) package ($1.5 \times 1.5 \times 0.37$ mm)
- Included output matching circuit
- Included very robust bandgap regulator (Small V_{CC} and T_A dependence)
- Included protection circuits for ESD

APPLICATION

- Low noise amplifier for GPS

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μ PC8236T6N-E2	μ PC8236T6N-E2-A	6-pin plastic TSON (T6N) (Pb-Free)	6S	<ul style="list-style-type: none">8 mm wide embossed tapingPin 1, 6 face the perforation side of the tapeQty 3 kpcs/reel

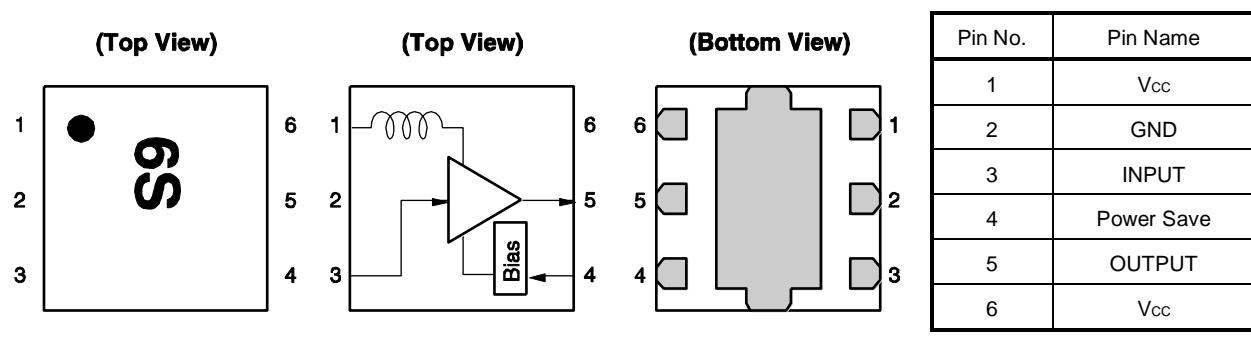
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: μ PC8236T6N-A

Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	V _{CC}	T _A = +25°C	4.0	V
Power-Saving Voltage	V _{PS}	T _A = +25°C	4.0	V
Total Power Dissipation	P _{tot}		150	mW
Operating Ambient Temperature	T _A		-40 to +85	°C
Storage Temperature	T _{stg}		-55 to +150	°C
Input Power	P _{in}		+10	dBm

RECOMMENDED OPERATING RANGE

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V _{CC}	1.6	2.7	3.3	V
Operating Ambient Temperature	T _A	-40	+25	+85	°C
Power Save Turn-on Voltage	V _{PSon}	1.0	—	V _{CC}	V
Power Save Turn-off Voltage	V _{PSoff}	0	—	0.4	V

ELECTRICAL CHARACTERISTICS

(T_A = +25°C, V_{CC} = V_{PS} = 2.7 V, f_{in} = 1 575 MHz, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	I _{CC}	No Signal (V _{PS} = 2.7 V)	5.0	6.5	8.0	mA
		At Power-Saving Mode (V _{PS} = 0 V)	—	—	1	μA
Power Gain	G _P	P _{in} = -35 dBm	17	19.5	22	dB
Noise Figure	NF		—	0.8	1.1	dB
Input Return Loss	R _{Lin}		7.5	11	—	dB
Output Return Loss	R _{Lout}		11	14	—	dB

STANDARD CHARACTERISTICS FOR REFERENCE 1

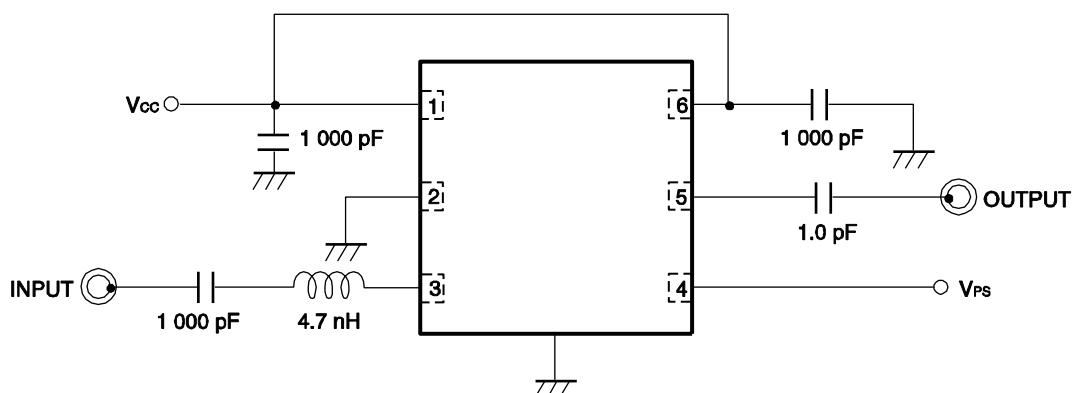
(TA = +25°C, Vcc = Vps = 2.7 V, fin = 1 575 MHz, unless otherwise specified)

Parameter	Symbol	Test Conditions	Reference	Unit
Input 3rd Order Intercept Point	IIP ₃	f _{in1} = 1 575 MHz, f _{in2} = 1 574 MHz	-3	dBm
Isolation	ISL		39	dB
Gain 1 dB Compression Input Power	P _{in (1 dB)}		-18	dBm

STANDARD CHARACTERISTICS FOR REFERENCE 2

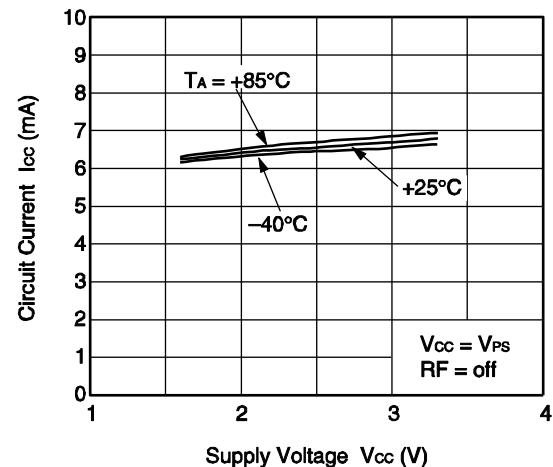
(TA = +25°C, Vcc = Vps = 1.8 V, fin = 1 575 MHz, unless otherwise specified)

Parameter	Symbol	Test Conditions	Reference	Unit
Circuit Current	I _{cc}	No Signal (V _{ps} = 1.8 V)	6.2	mA
Power Gain	G _P	P _{in} = -35 dBm	19.1	dB
Noise Figure	NF		0.8	dB
Input 3rd Order Intercept Point	IIP ₃	f _{in1} = 1 575 MHz, f _{in2} = 1 574 MHz	-5	dBm
Input Return Loss	RL _{in}		11	dB
Output Return Loss	RL _{out}		14	dB
Isolation	ISL		39	dB
Gain 1 dB Compression Input Power	P _{in (1 dB)}		-19	dBm

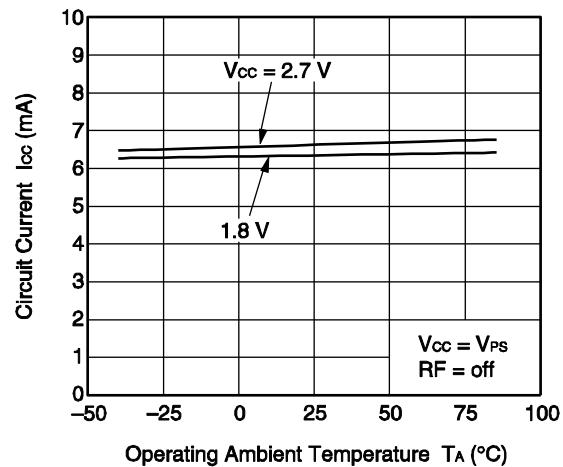
TEST CIRCUIT

TYPICAL CHARACTERISTICS ($T_A = +25^\circ\text{C}$, unless otherwise specified)

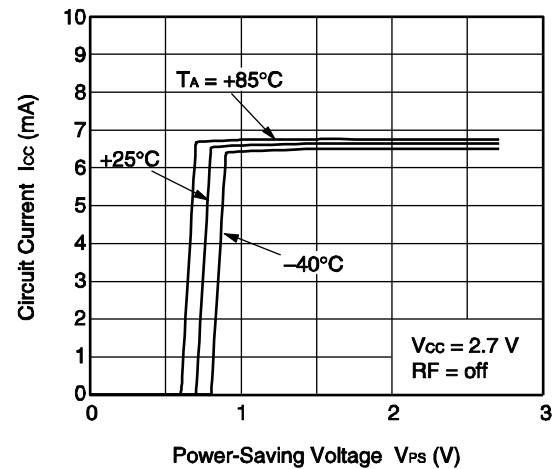
CIRCUIT CURRENT vs. SUPPLY VOLTAGE



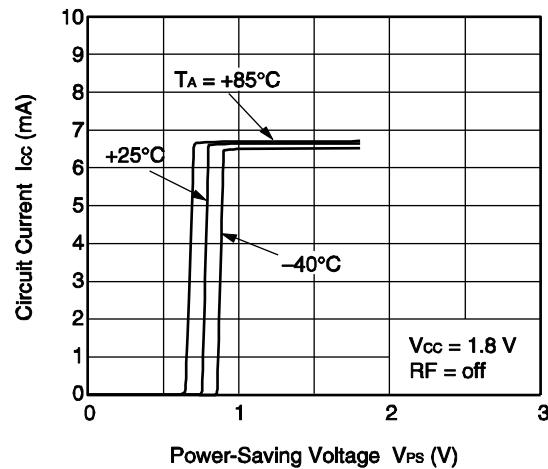
CIRCUIT CURRENT vs. OPERATING AMBIENT TEMPERATURE



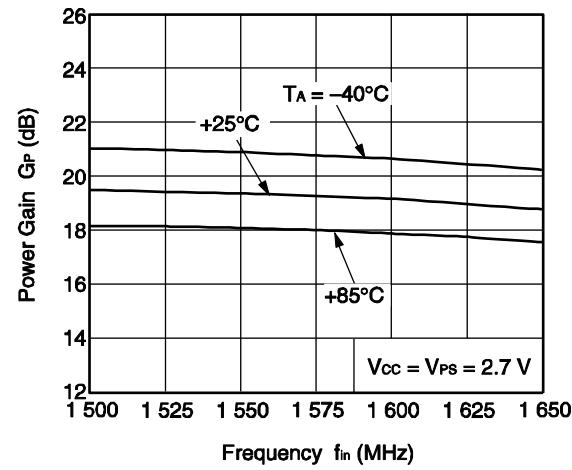
CIRCUIT CURRENT vs. POWER-SAVING VOLTAGE



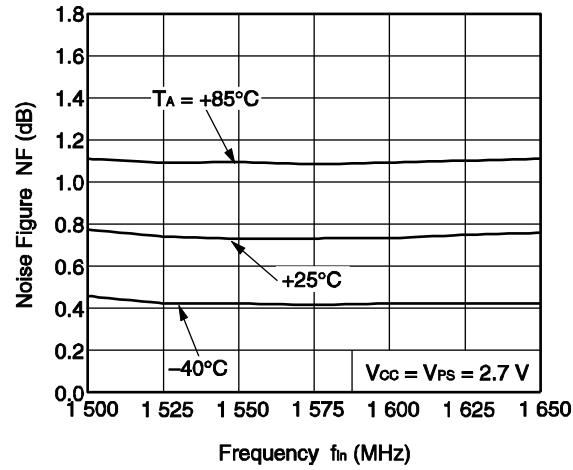
CIRCUIT CURRENT vs. POWER-SAVING VOLTAGE



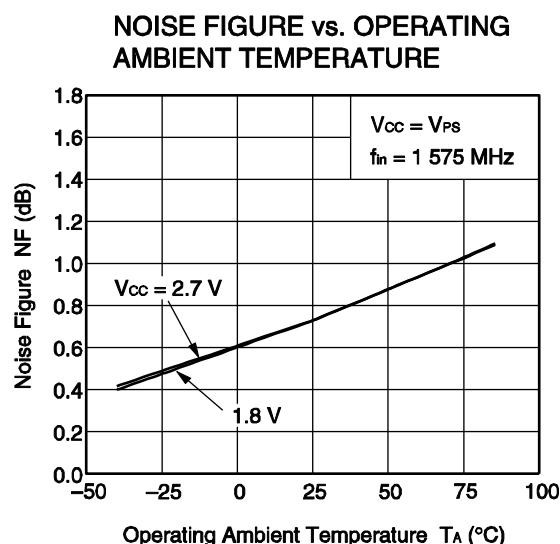
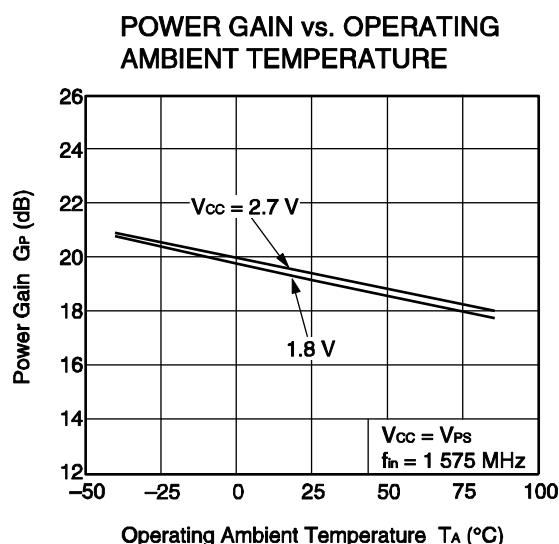
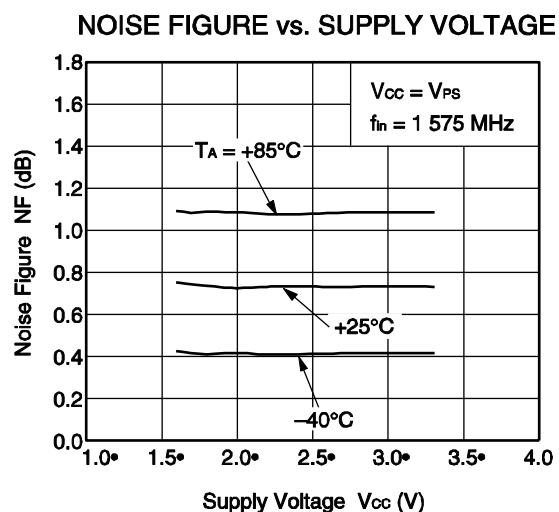
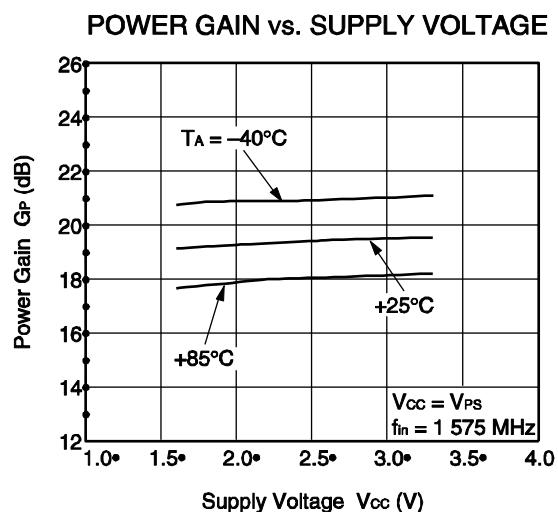
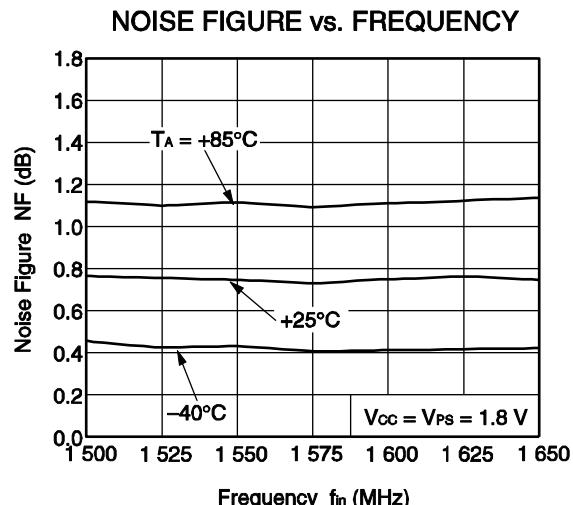
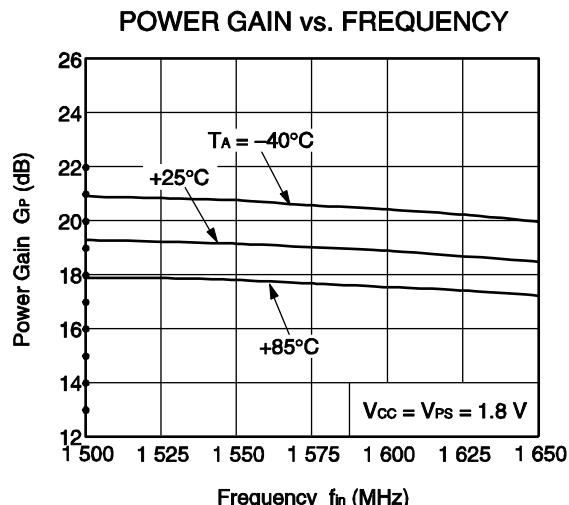
POWER GAIN vs. FREQUENCY



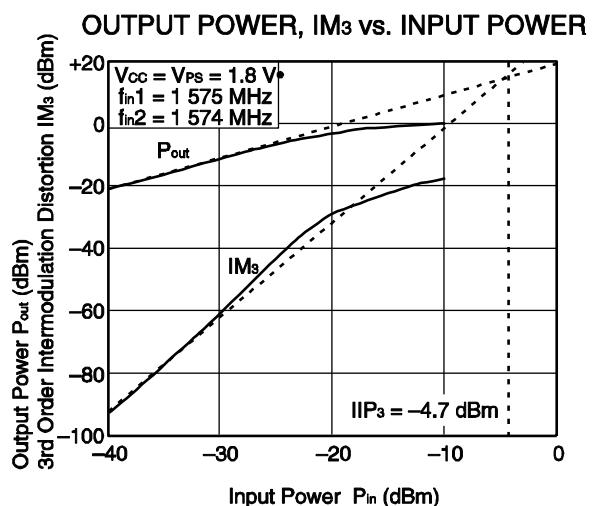
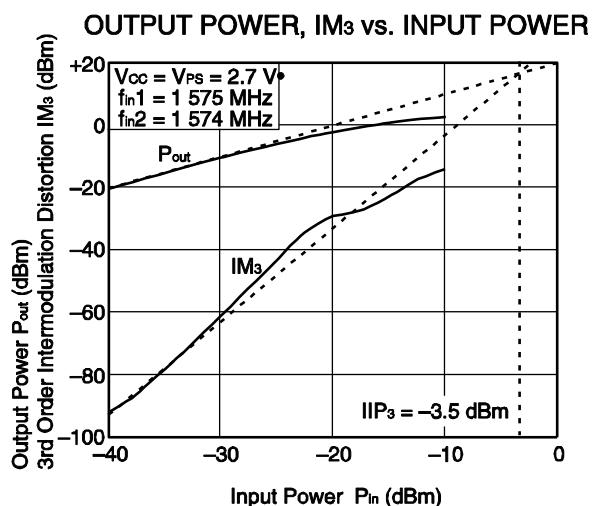
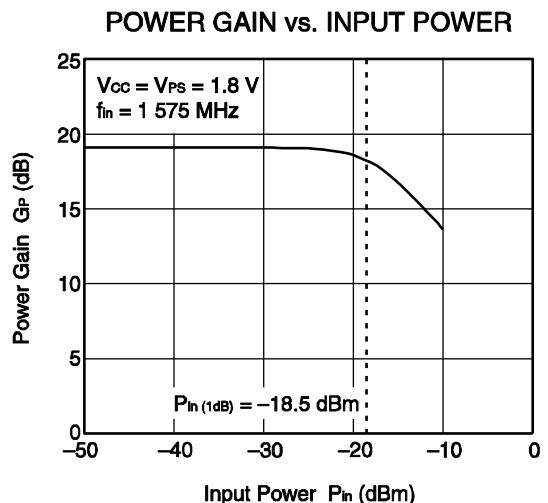
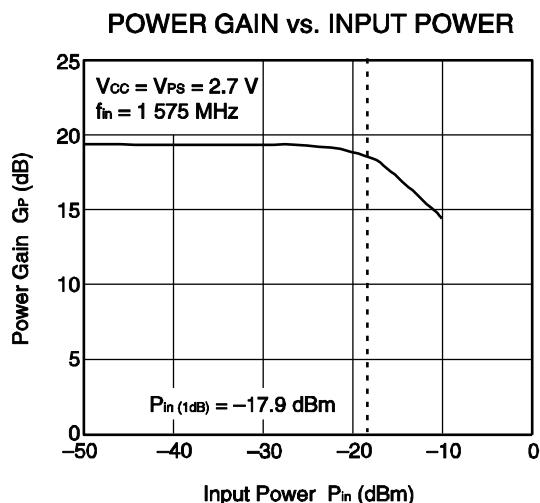
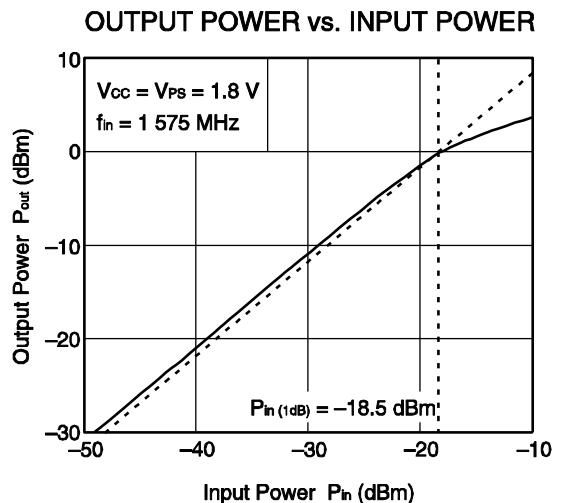
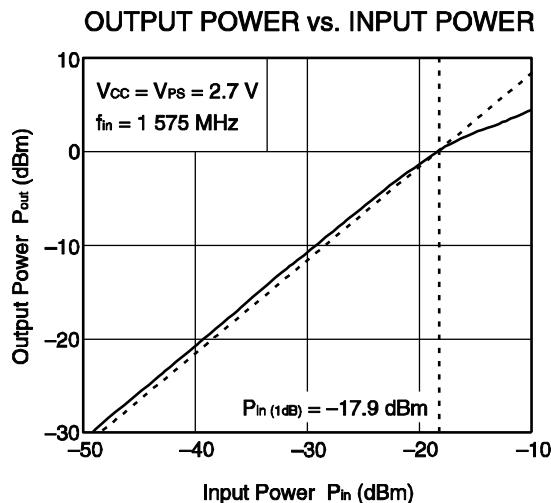
NOISE FIGURE vs. FREQUENCY



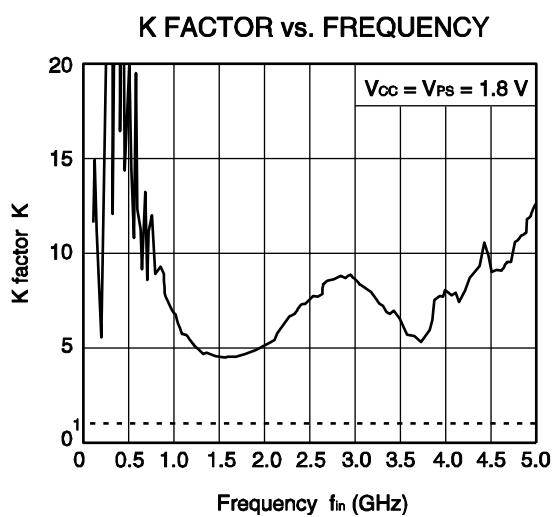
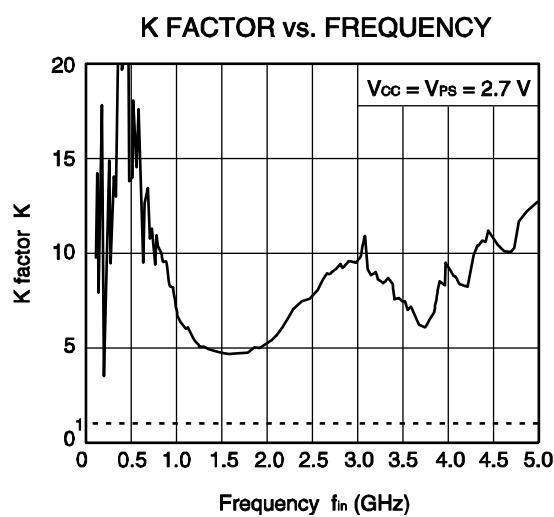
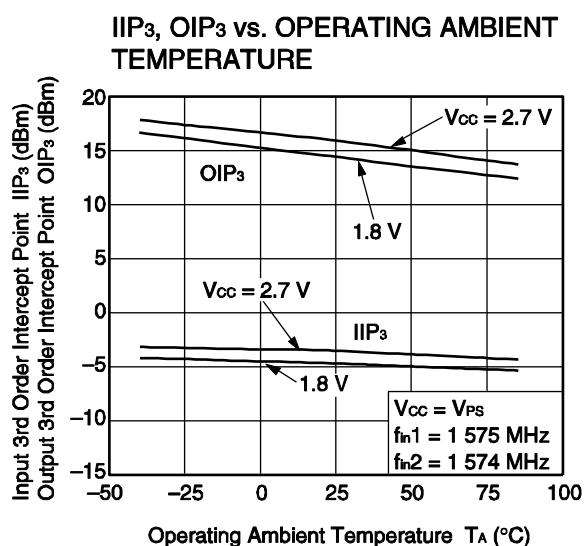
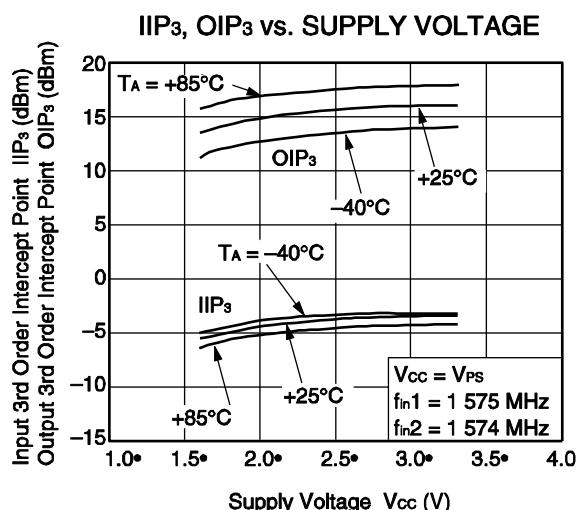
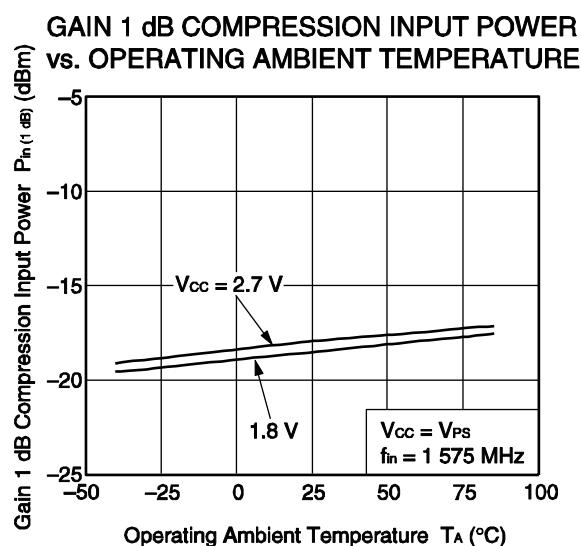
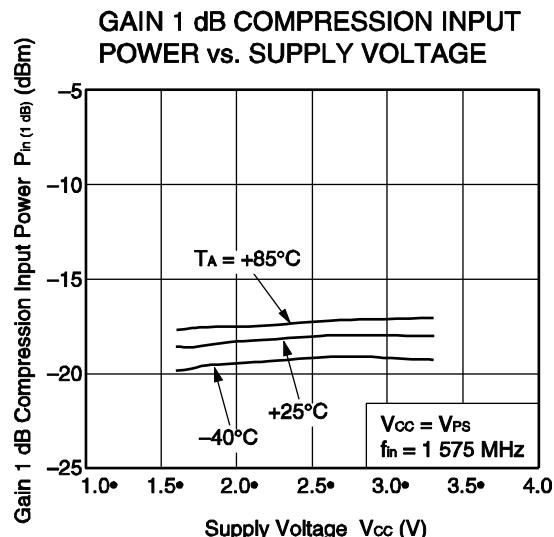
Remark The graphs indicate nominal characteristics.



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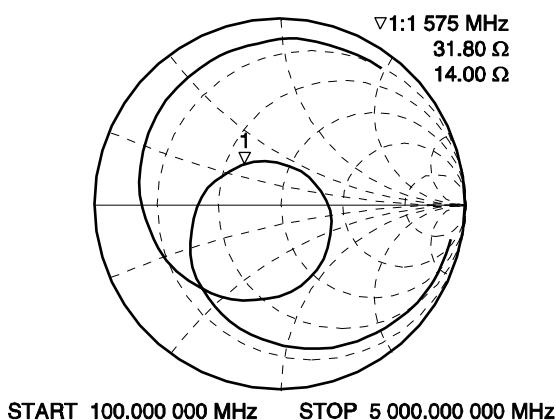
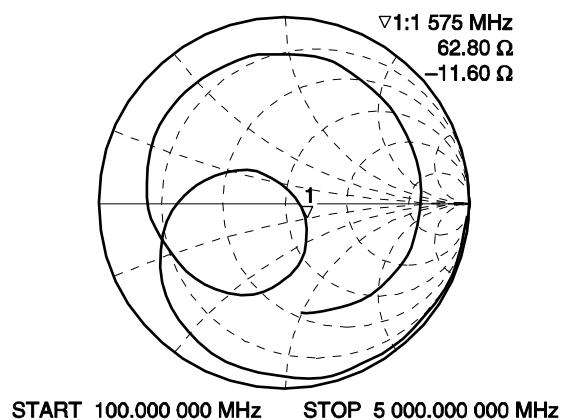


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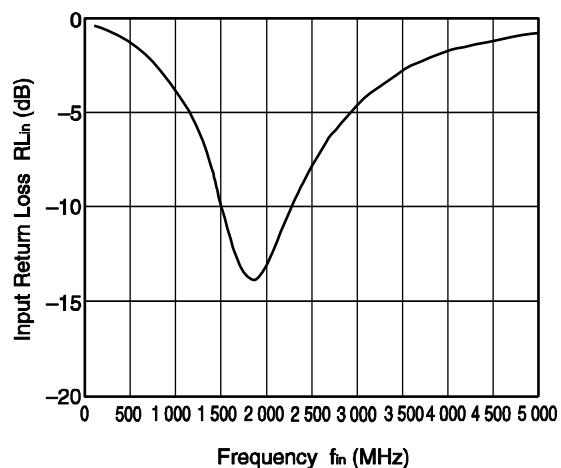


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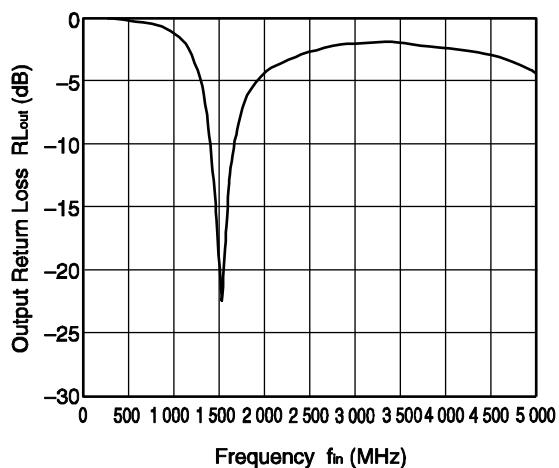
S-PARAMETERS ($T_A = +25^\circ\text{C}$, $V_{CC} = V_{PS} = 2.7 \text{ V}$, monitored at connector on board)

S₁₁-FREQUENCYS₂₂-FREQUENCY

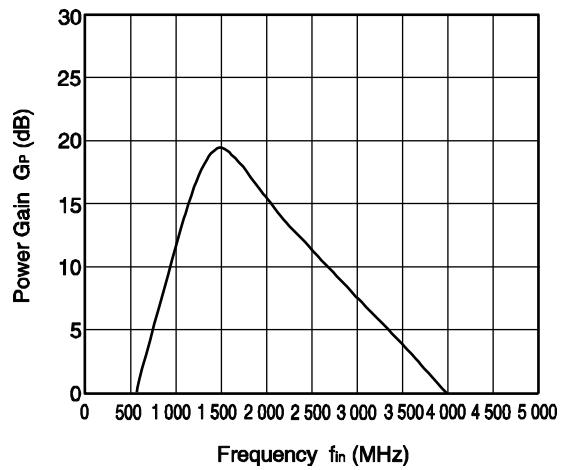
INPUT RETURN LOSS vs. FREQUENCY



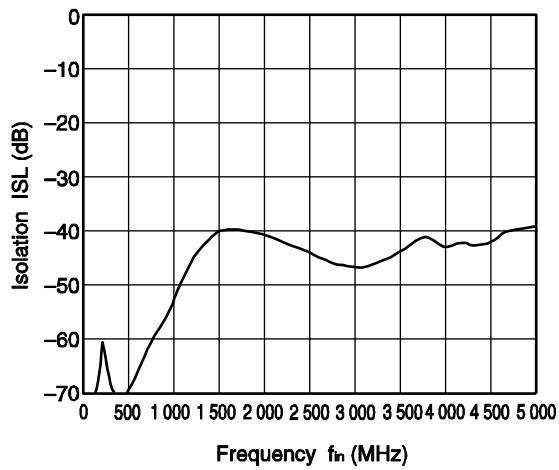
OUTPUT RETURN LOSS vs. FREQUENCY



POWER GAIN vs. FREQUENCY

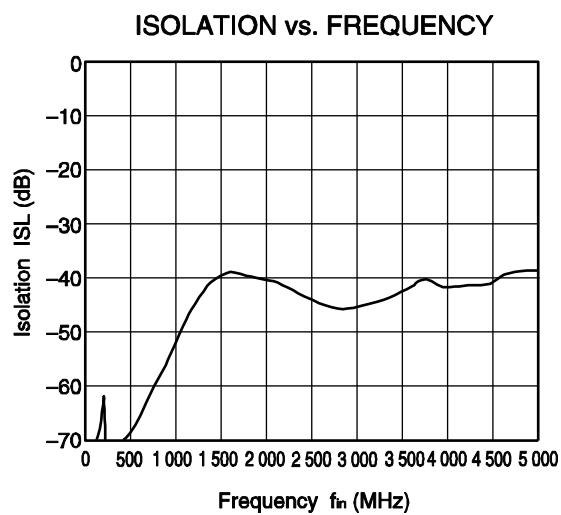
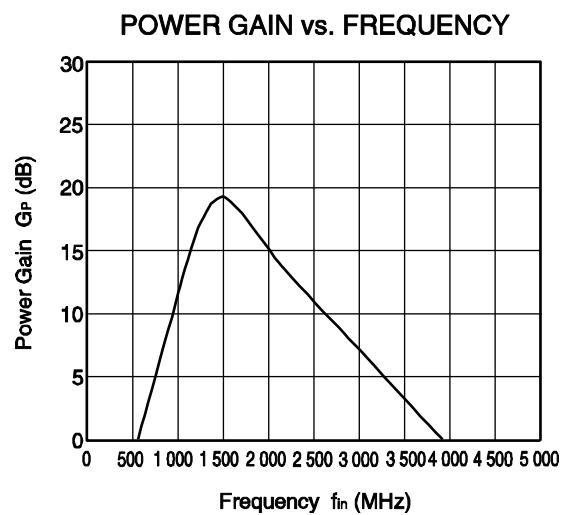
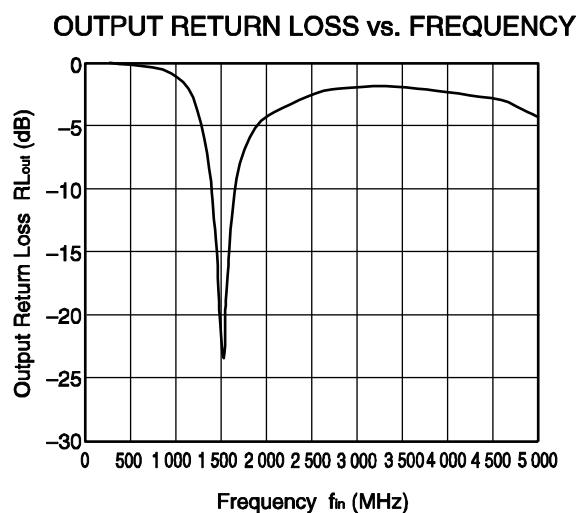
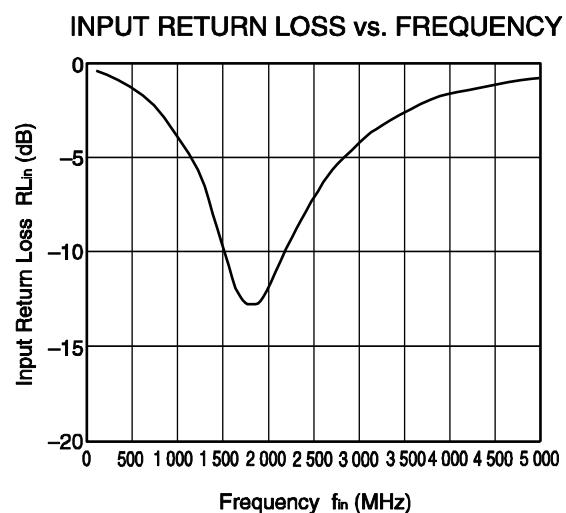
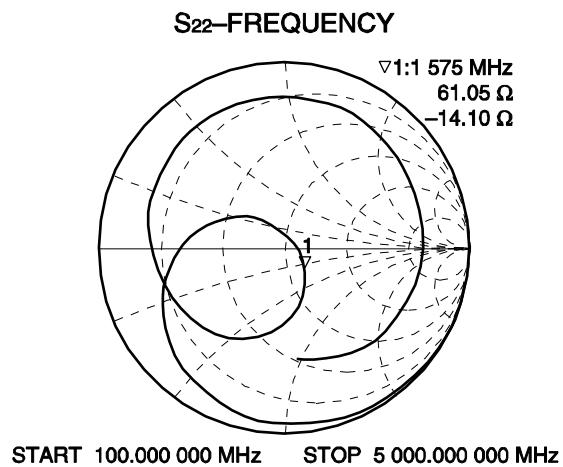
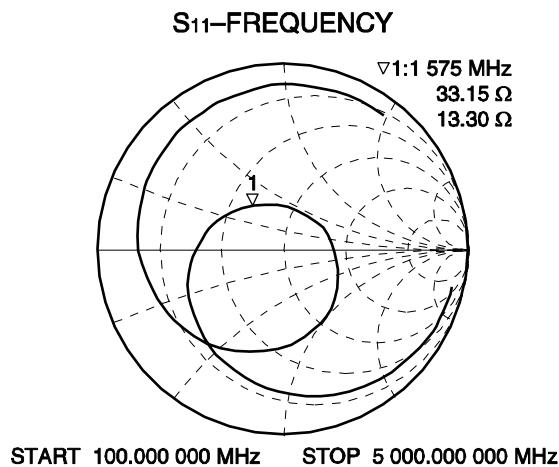


ISOLATION vs. FREQUENCY



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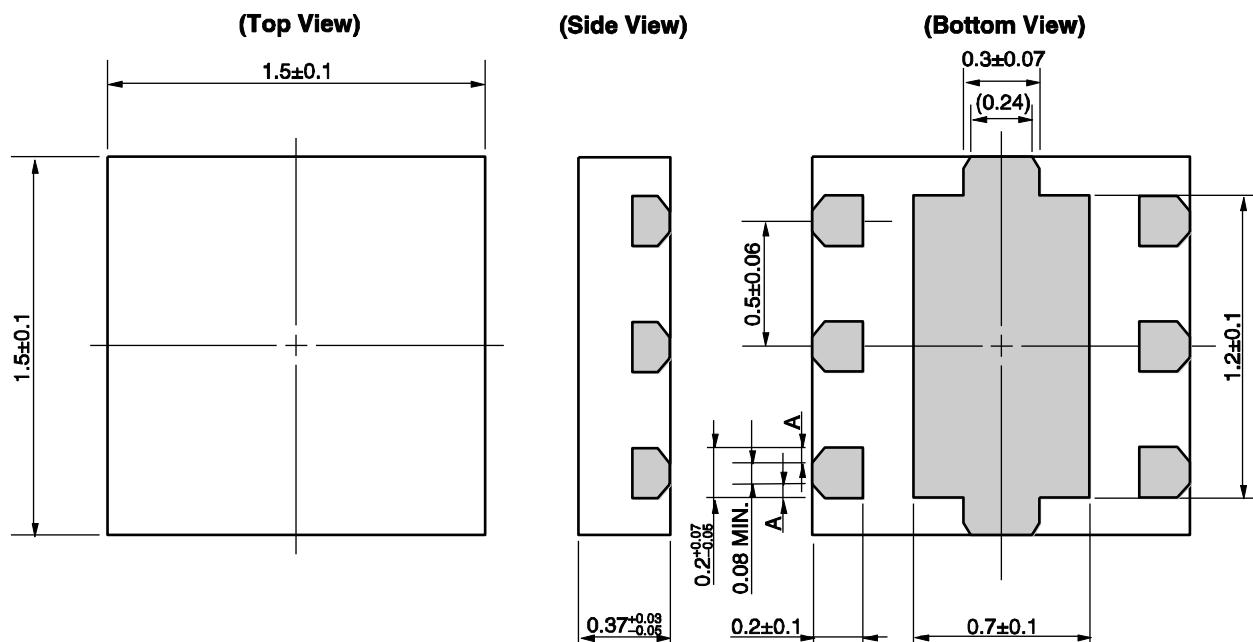
S-PARAMETERS ($T_A = +25^\circ\text{C}$, $V_{CC} = V_{PS} = 1.8 \text{ V}$, monitored at connector on board)



Remark The graphs indicate nominal characteristics.

PACKAGE DIMENSIONS

6-PIN PLASTIC TSON (T6N) (UNIT: mm)

**Remark** $A > 0$

() : Reference value

NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.
- (4) Do not supply DC voltage to INPUT pin.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



OCEAN CHIPS

Океан Электроники

Поставка электронных компонентов

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Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибутором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибутором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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Электронная почта: ocean@oceanchips.ru

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